# nexperia

# **Final Product Change Notification**

Issue Date: 01-Apr-2020 Effective Date: 14-Jul-2020

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For detailed information we invite you to view this notification online

# 202001004F01



Change Category [X] Wafer Fab Process

Release of 8 inch wafer diameter for transistors

### **Details of this Change**

Release of 8 inch wafer diameter for transistors.

Old products: Production using 6 inch wafer diameter Changed products: Production using 6 and 8 inch wafer diameter

In addition, for the BCM846BS wire bond material will be changed from gold (Au) to copper (Cu) and the 2nd source mold compound will be released, for the PMST3906 lead frame design version SOT323 R1 will be introduced.

Please refer to the Self Qualification Report for details and list of affected product types. Production on 8 inch wafer diameter implies the use of the respective 8 inch wafer process technology.

### Why do we Implement this Change

- Capacity expansion in wafer fab

- Next phase in 8 inch release after start with 8 inch implementation of bipolar transistors in 2011

Continued alignment with world technology trends on state of the art production tools for discrete components

- Increase flexibility and volume ramp-up

Identification of Affected Products

[] Assembly [] Product Marking [] Test [] Design Process Location [X] Assembly [] Mechanical Specification[]Test [X] Wafer Fab Materials [] Errata Materials Process [] Wafer Fab Location [] Assembly [] []Test Packing/Shipping/Labeling Equipment Location

[] Electrical spec./Test coverage

The 8 inch products can be identified by a marker on the die surface. Changed products can be identified by date code after implementation.

Product Availability								
Sample Information								
Samples are available upon request								
Latest sample request date for PCN samples is 01-May-2020.								
Production								
Planned first shipment 14-Jul-2020								
Impact								
No impact to the products' functionality anticipated.								
Data Sheet Revision								
No impact to existing datasheet								
Disposition of Old Products								
Existing inventory will be shipped until depleted								
Supply using 6 inch wafer will be continued in parallel to 8 inch wafer production.								
Related Notifications								
Notification Issue Date Effective DateTitle								
201411005F0126-Jan- 2015 10-May-2015 Change of bond wire from Au to Cu and release of 2nd source mold compound in SOT363								
201602003F0122-May- 03-Sep-2016 Release of 8 inch wafer diameter for low VCEsat (BISS) 2016 transistors								
201712005F0130-Apr-201829-Jul-2018 Change of lead frame version in SOT323 package								
201811008F0110-Apr-201923-Jul-2019 Release of 8 inch wafer diameter for general-purpose bipolar transistors								
201905004F0107-Jul-2019 20-Oct-2019 Release of 8 inch wafer diameter for transistors in SOT883 and SOT23								

#### **Timing and Logistics**

Your acknowledgement of this change, conform JEDEC J-STD-046, is expected till 01-May-2020. Lack of acknowledgement of the PCN constitutes acceptance of the change.

#### **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please contact Nexperia "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local Nexperia Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly: **e-mail address** PCN-Bipolar.Discretes@nexperia.com

At Nexperia B.V. we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

#### About Nexperia B.V.

We at Nexperia are the efficiency semiconductor company. We deliver over 90 billion products a year and as such service thousands of global customers, both directly and through our extensive network of channel partners. We are at the heart of billions of electronic devices in the Automotive, Mobile, Industrial, Consumer, Computing, and Communication Infrastructure segments.

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Changed Orderable Part#	Changed Part 12NC	Changed Part Number	Changed Part Description	Package Outline	Package Name	Status	Product Line
PBSS4160T,215	934057667215	PBSS4160T	BISS	SOT23	TO-236AB	RFS	Bipolar Discretes
BCM857BS,135	934058729135	BCM857BS	Matched pair	SOT363	SC-88	RFS	Bipolar Discretes
PBSS5160T,215	934057668215	PBSS5160T	BISS	SOT23	TO-236AB	RFS	Bipolar Discretes
PMST3906,115	934026930115	PMST3906	Switching transistor	SOT323	SC-70	RFS	Bipolar Discretes
BCM847BS,115	934058507115	BCM847BS	Matched pair	SOT363	SC-88	RFS	Bipolar Discretes
BCM846BSX	934069545115	BCM846BS	Matched pair	SOT363	SC-88	RFS	Bipolar Discretes
PMBT3946YPN,125	934061453125	PMBT3946YPN	GENERAL PURPOSE TRANSISTOR	SOT363	SC-88	RFS	Bipolar Discretes
PBSS5160U,115	934058123115	PBSS5160U	BISS	SOT323	SC-70	RFS	Bipolar Discretes
BCM856BS,115	934062056115	BCM856BS	COMPLEX DISCRETE	SOT363	SC-88	RFS	Bipolar Discretes
BCM857BS,115	934058729115	BCM857BS	Matched pair	SOT363	SC-88	RFS	Bipolar Discretes
BCM847BS,135	934058507135	BCM847BS	Matched pair	SOT363	SC-88	RFS	Bipolar Discretes
PBSS5540Z,115	934055496115	PBSS5540Z	BISS	SOT223	SC-73	RFS	Bipolar Discretes
PBSS5540ZF	934055496135	PBSS5540Z	BISS	SOT223	SC-73	RFS	Bipolar Discretes
PBSS4540Z,115	934055495115	PBSS4540Z	BISS	SOT223	SC-73	RFS	Bipolar Discretes
PMBT3946YPN,115	934061453115	PMBT3946YPN	GENERAL PURPOSE TRANSISTOR	SOT363	SC-88	RFS	Bipolar Discretes